



PXP6R7-30QL

30 V, P-channel Trench MOSFET

5 January 2021

Product data sheet

1. General description

P-channel enhancement mode Field-Effect Transistor (FET) in an MLPAK33 (SOT8002) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

2. Features and benefits

- Logic level compatible
- Trench MOSFET technology
- MLPAK33 package (3.3 x 3.3 mm footprint)

3. Applications

- High-side load switch
- Battery management
- DC-to-DC conversion
- Switching circuits

4. Quick reference data

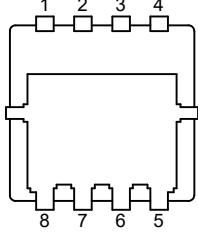
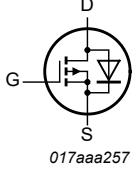
Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{DS}	drain-source voltage	$T_j = 25\text{ °C}$	-	-	-30	V
V_{GS}	gate-source voltage		-20	-	20	V
I_D	drain current	$V_{GS} = -10\text{ V}; T_{amb} = 25\text{ °C}; t \leq 5\text{ s}$	[1]	-	-20.7	A
Static characteristics						
R_{DSon}	drain-source on-state resistance	$V_{GS} = -10\text{ V}; I_D = -12.6\text{ A}; T_j = 25\text{ °C}$	-	5.7	6.7	m Ω
		$V_{GS} = -4.5\text{ V}; I_D = -10.5\text{ A}; T_j = 25\text{ °C}$	-	7.7	9.6	m Ω

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm².

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source	 <p>MLPAK33 (SOT8002-1)</p>	 <p>017aaa257</p>
2	S	source		
3	S	source		
4	G	gate		
5	D	drain		
6	D	drain		
7	D	drain		
8	D	drain		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PXP6R7-30QL	MLPAK33	plastic thermal enhanced surface mounted package; mini leads; 8 terminals; pitch 0.65 mm; 3.3 x 3.3 x 0.8 mm body	SOT8002-1

7. Marking

Table 4. Marking codes

Type number	Marking code
PXP6R7-30QL	9AK

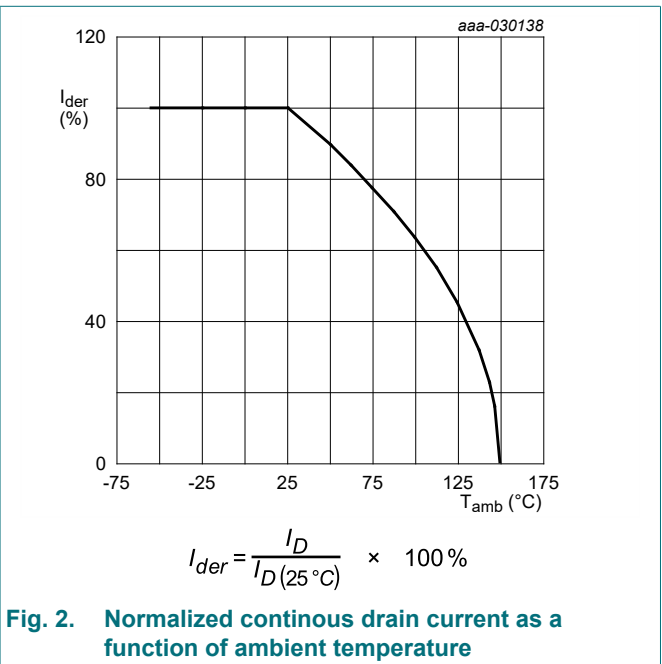
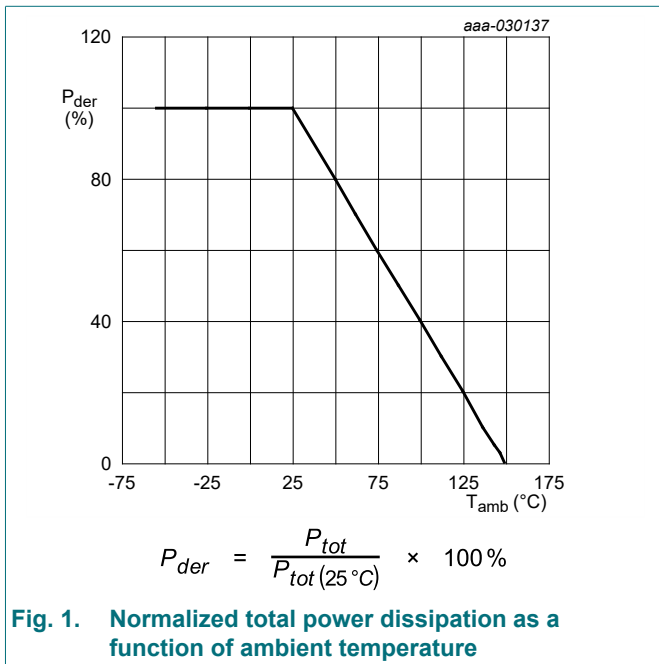
8. Limiting values

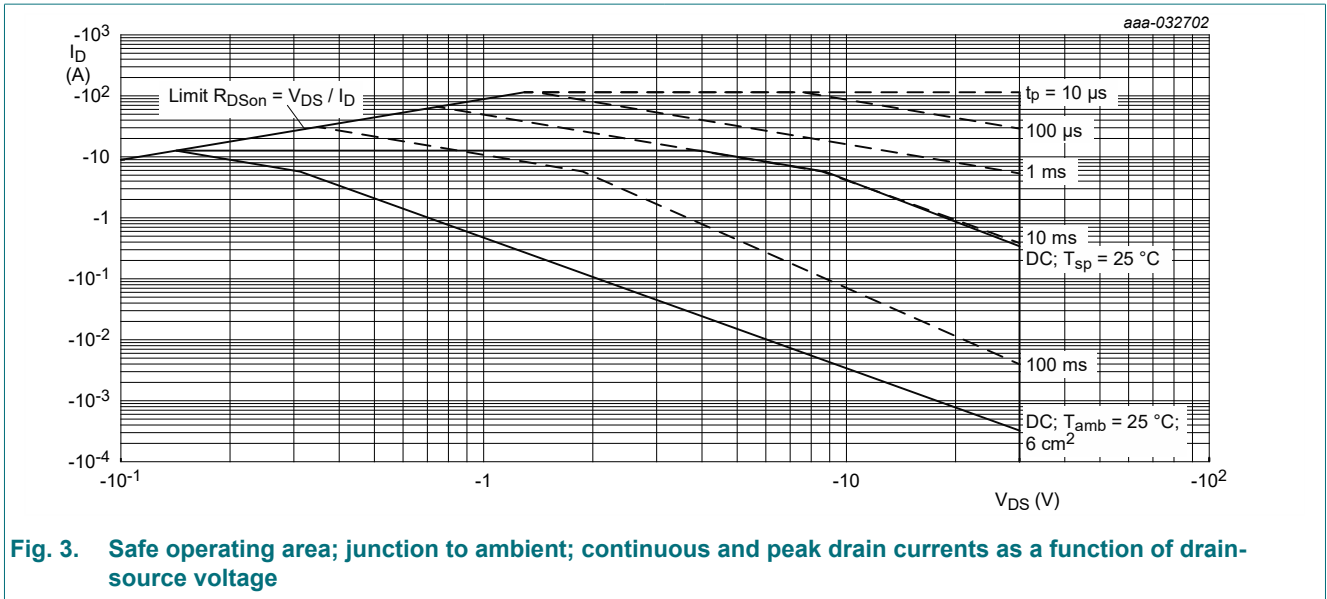
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit	
V _{DS}	drain-source voltage	T _j = 25 °C	-	-30	V	
V _{GS}	gate-source voltage		-20	20	V	
I _D	drain current	V _{GS} = -10 V; T _{amb} = 25 °C; t ≤ 5 s	[1]	-	-20.7	A
		V _{GS} = -10 V; T _{amb} = 25 °C	[1]	-	-12.6	A
		V _{GS} = -10 V; T _{amb} = 100 °C	[1]	-	-8	A
		V _{GS} = -10 V; T _{sp} = 25 °C		-	-66.6	A
I _{DM}	peak drain current	T _{amb} = 25 °C; single pulse; t _p ≤ 10 μs	-	-115	A	
P _{tot}	total power dissipation	T _{amb} = 25 °C; t ≤ 5 s	[1]	-	4.8	W
		T _{amb} = 25 °C	[1]	-	1.8	W
		T _{sp} = 25 °C		-	50	W
T _j	junction temperature		-55	150	°C	
T _{amb}	ambient temperature		-55	150	°C	
T _{stg}	storage temperature		-65	150	°C	
Source-drain diode						
I _S	source current	T _{amb} = 25 °C	[1]	-	-1.7	A

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm².





9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	145	185	K/W
			[2]	-	55	70	K/W
		in free air; $t \leq 5$ s	[2]	-	21	26	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point			-	1.5	2.5	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm².

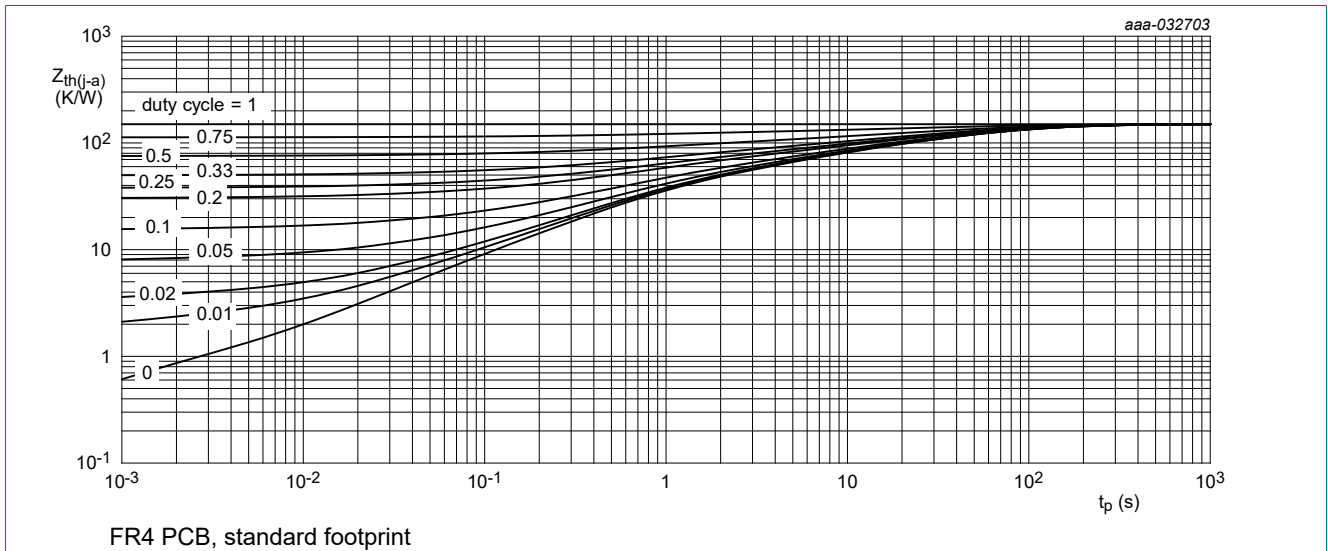


Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

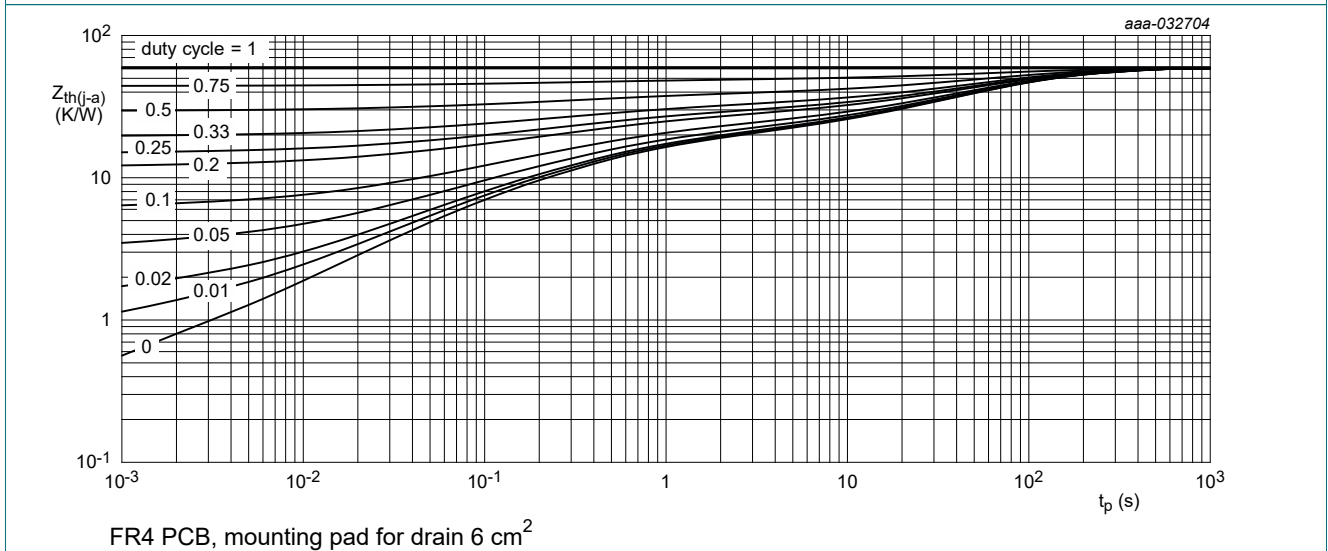


Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static characteristics						
$V_{(BR)DSS}$	drain-source breakdown voltage	$I_D = -250 \mu\text{A}$; $V_{GS} = 0 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$	-30	-	-	V
V_{GSth}	gate-source threshold voltage	$I_D = -250 \mu\text{A}$; $V_{DS} = V_{GS}$; $T_j = 25 \text{ }^\circ\text{C}$	-1	-1.4	-2.5	V
I_{DSS}	drain leakage current	$V_{DS} = -30 \text{ V}$; $V_{GS} = 0 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$	-	-	-1	μA
I_{GSS}	gate leakage current	$V_{GS} = -20 \text{ V}$; $V_{DS} = 0 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$	-	-	-0.1	μA
		$V_{GS} = 20 \text{ V}$; $V_{DS} = 0 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$	-	-	0.1	μA
R_{DSon}	drain-source on-state resistance	$V_{GS} = -10 \text{ V}$; $I_D = -12.6 \text{ A}$; $T_j = 25 \text{ }^\circ\text{C}$	-	5.7	6.7	m Ω
		$V_{GS} = -10 \text{ V}$; $I_D = -12.6 \text{ A}$; $T_j = 150 \text{ }^\circ\text{C}$	-	9.6	11.3	m Ω
		$V_{GS} = -4.5 \text{ V}$; $I_D = -10.5 \text{ A}$; $T_j = 25 \text{ }^\circ\text{C}$	-	7.7	9.6	m Ω
g_{fs}	forward transconductance	$V_{DS} = -10 \text{ V}$; $I_D = -12.6 \text{ A}$; $T_j = 25 \text{ }^\circ\text{C}$	-	45	-	S
R_G	gate resistance	$f = 1 \text{ MHz}$	-	3.7	-	Ω
Dynamic characteristics						
$Q_{G(tot)}$	total gate charge	$V_{DS} = -15 \text{ V}$; $I_D = -12.6 \text{ A}$; $V_{GS} = -10 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$	-	88.6	133	nC
		$V_{DS} = -15 \text{ V}$; $I_D = -10.5 \text{ A}$; $V_{GS} = -4.5 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$	-	44.3	66.5	nC
Q_{GS}	gate-source charge	$T_j = 25 \text{ }^\circ\text{C}$	-	10.2	-	nC
$Q_{GS(th)}$	pre-threshold gate-source charge		-	3.9	-	nC
$Q_{GS(th-pl)}$	post-threshold gate-source charge		-	6.3	-	nC
Q_{GD}	gate-drain charge		-	17.6	-	nC
V_{GSpl}	gate-source plateau voltage	$V_{DS} = -15 \text{ V}$; $I_D = -10.5 \text{ A}$; $T_j = 25 \text{ }^\circ\text{C}$	-	-2.4	-	V
C_{iss}	input capacitance	$V_{DS} = -15 \text{ V}$; $f = 1 \text{ MHz}$; $V_{GS} = 0 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$	-	4400	-	pF
C_{oss}	output capacitance		-	470	-	pF
C_{rss}	reverse transfer capacitance		-	410	-	pF
$t_{d(on)}$	turn-on delay time	$V_{DS} = -15 \text{ V}$; $I_D = -10.5 \text{ A}$; $V_{GS} = -4.5 \text{ V}$; $R_{G(ext)} = 5 \text{ } \Omega$; $T_j = 25 \text{ }^\circ\text{C}$	-	17	-	ns
t_r	rise time		-	67	-	ns
$t_{d(off)}$	turn-off delay time		-	61	-	ns
t_f	fall time		-	45	-	ns
Source-drain diode						
V_{SD}	source-drain voltage	$I_S = -1.7 \text{ A}$; $V_{GS} = 0 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$	-	-0.7	-1.2	V
t_{rr}	reverse recovery time	$I_S = -1.7 \text{ A}$; $dI_S/dt = 100 \text{ A}/\mu\text{s}$; $V_{GS} = -4.5 \text{ V}$; $V_{DS} = -15 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$	-	25	-	ns
Q_r	recovered charge		-	15	-	nC
t_a	reverse recovery rise time		-	11	-	ns
t_b	reverse recovery fall time		-	14	-	ns

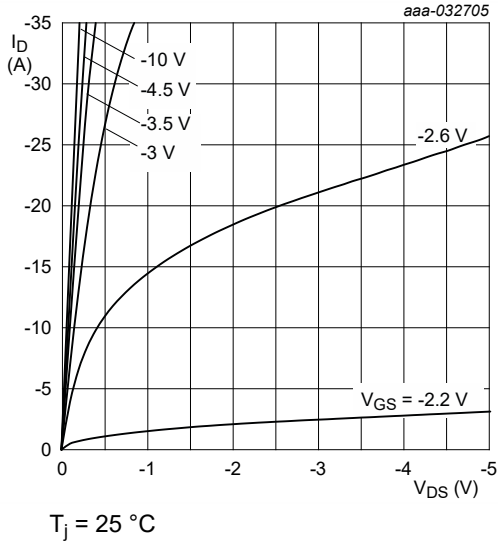


Fig. 6. Output characteristics: drain current as a function of drain-source voltage; typical values

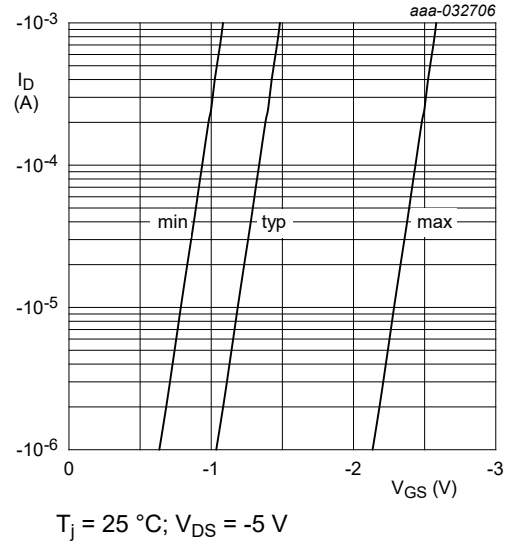


Fig. 7. Sub-threshold drain current as a function of gate-source voltage

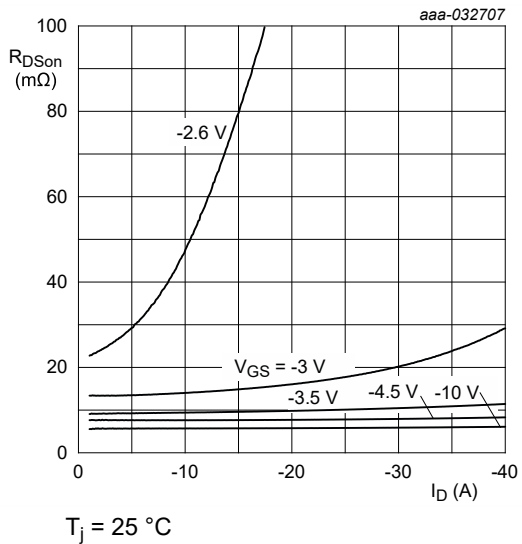


Fig. 8. Drain-source on-state resistance as a function of drain current; typical values

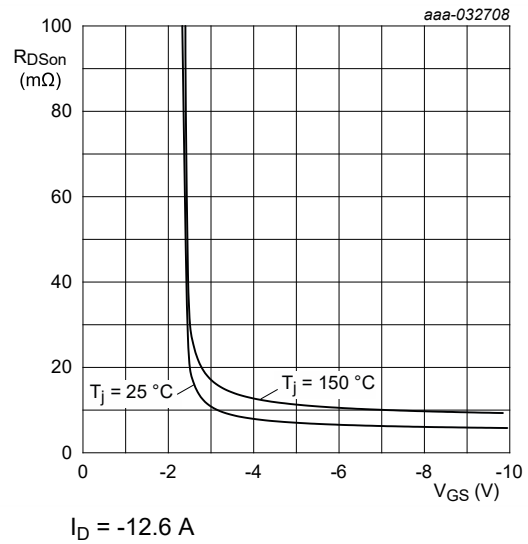


Fig. 9. Drain-source on-state resistance as a function of gate-source voltage; typical values

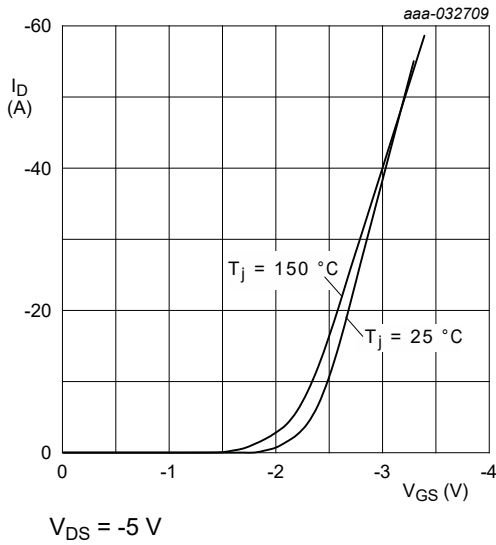


Fig. 10. Transfer characteristics: drain current as a function of gate-source voltage; typical values

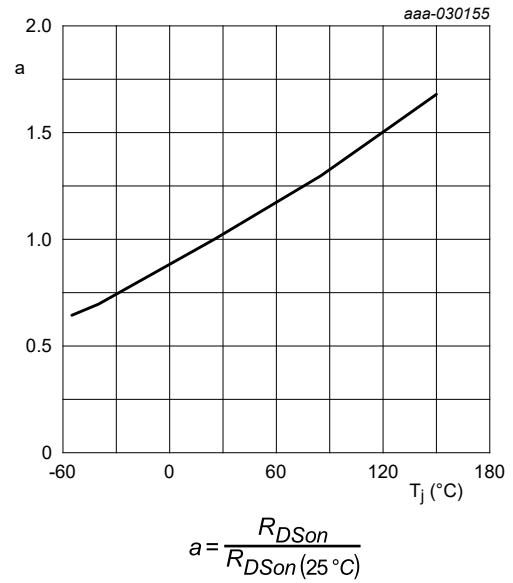


Fig. 11. Normalized drain-source on-state resistance as a function of junction temperature; typical values

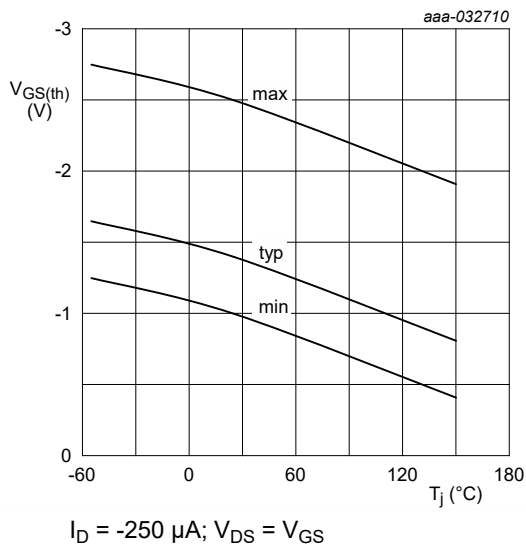


Fig. 12. Gate-source threshold voltage as a function of junction temperature

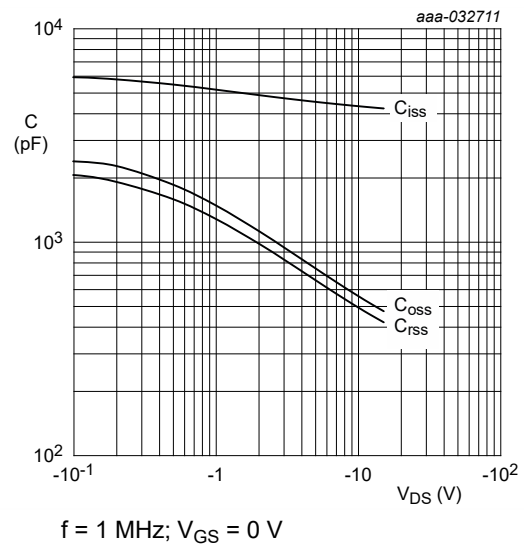
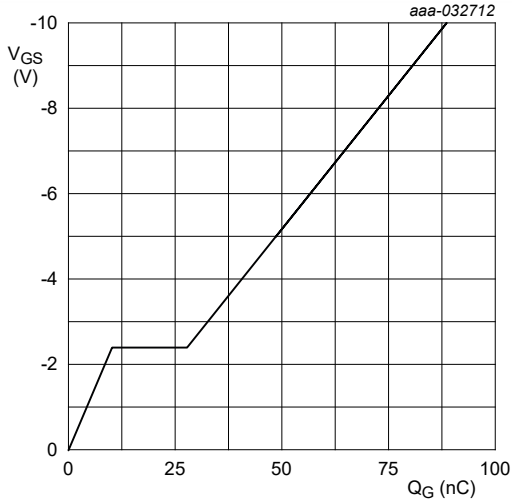


Fig. 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values



$V_{DS} = -15\text{ V}; I_D = -10.5\text{ A}; T_j = 25\text{ }^\circ\text{C}$

Fig. 14. Gate-source voltage as a function of gate charge; typical values

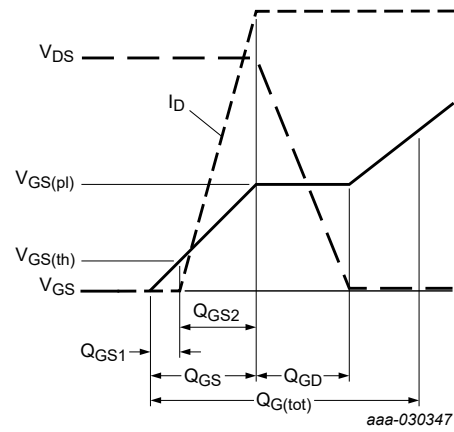


Fig. 15. Gate charge waveform definitions

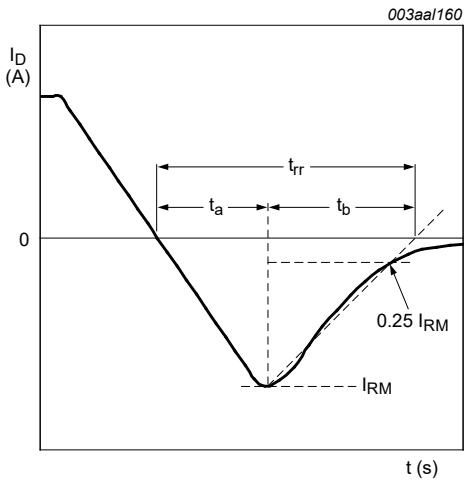
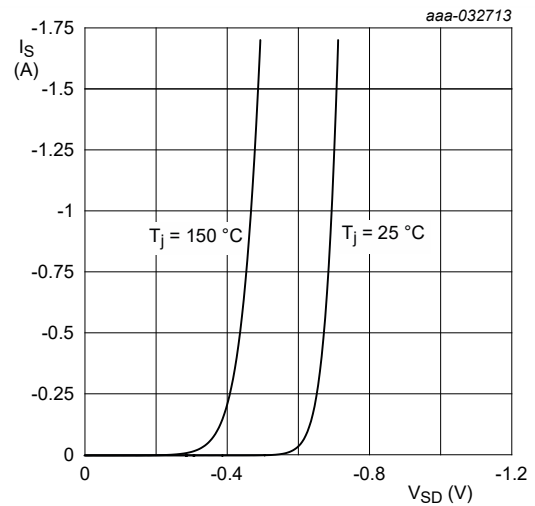


Fig. 16. Reverse recovery timing definition



$V_{GS} = 0\text{ V}$

Fig. 17. Source current as a function of source-drain voltage; typical values

11. Test information

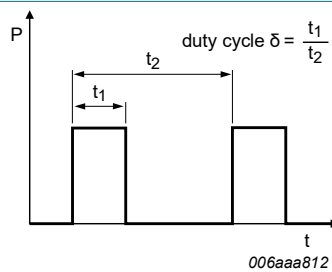
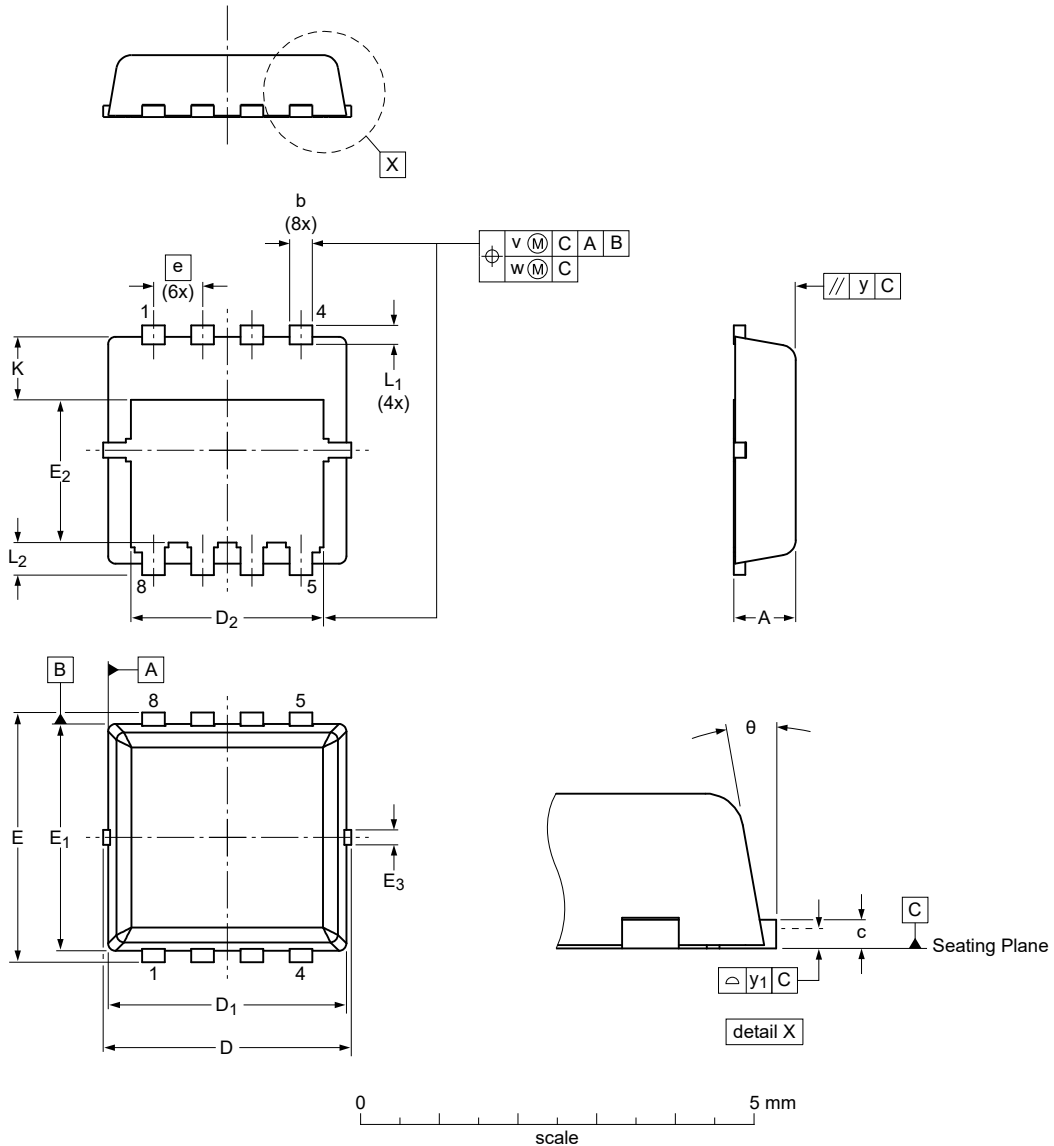


Fig. 18. Duty cycle definition

12. Package outline

MLPAK33: plastic thermal enhanced surface mounted package; mini leads; 8 terminals;
pitch 0.65 mm; 3.3 x 3.3 x 0.8 mm body

SOT8002-1



Dimensions (mm are the original dimensions)

Unit	A	b	c	D	D ₁	D ₂	e	E	E ₁	E ₂	E ₃	K	L ₁	L ₂	θ	y	y ₁	v	w
max	0.90	0.35	0.18	3.50	3.25	2.65		3.50	3.10	1.99	0.25		0.40	0.58	12°				
mm	nom	0.80	0.30	3.30	3.15	2.55	0.65	3.30	3.00	1.89	0.20	0.65 (ref)	0.25	0.43	10°	0.05	0.05	0.1	0.05
	min	0.70	0.25	3.10	3.05	2.45		3.10	2.90	1.79	0.15		0.10	0.28	8°				

sot8002-1_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	EIAJ			
SOT8002-1						19-12-19 20-01-09

Fig. 19. Package outline MLPAK33 (SOT8002-1)

13. Soldering

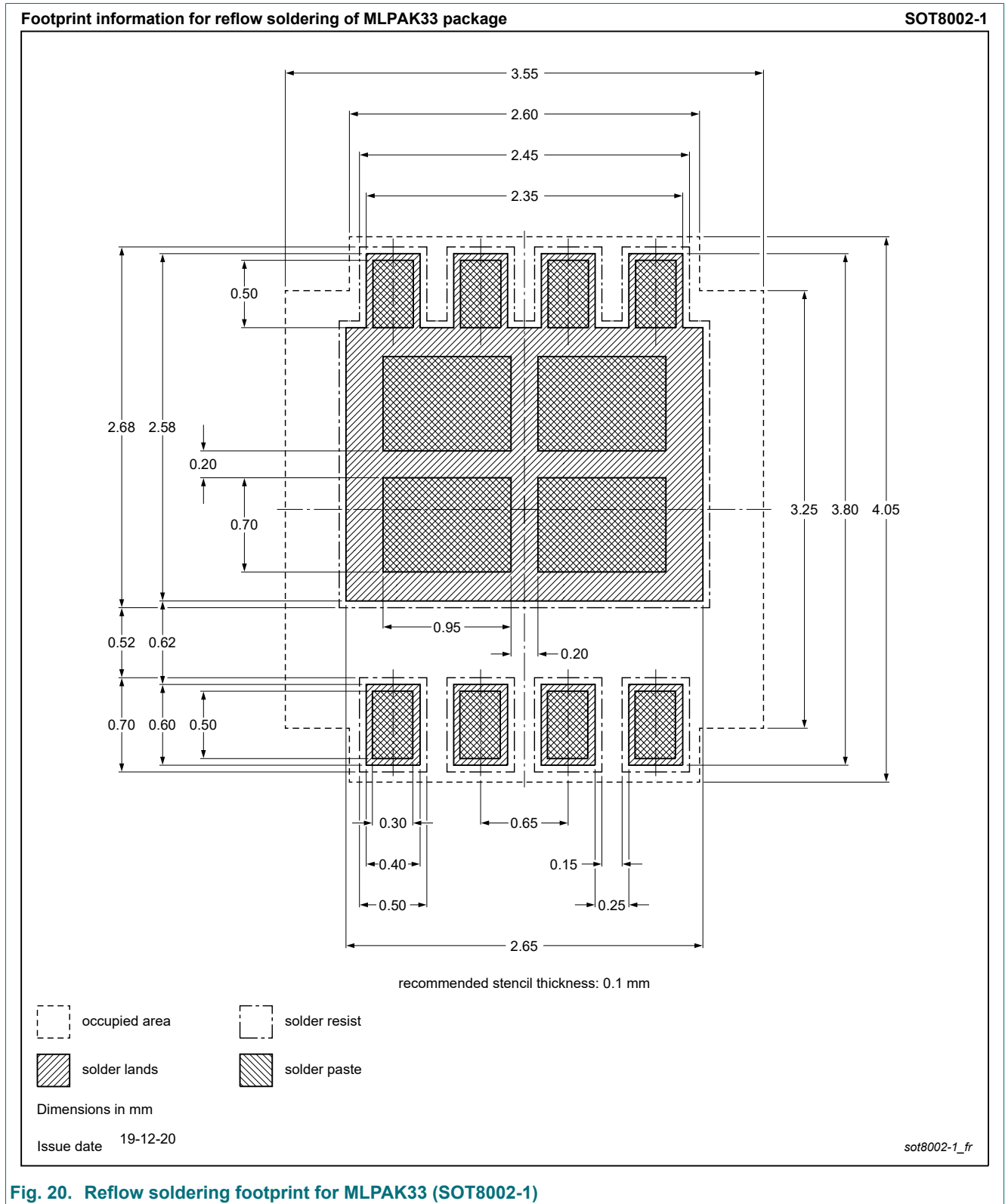


Fig. 20. Reflow soldering footprint for MLPAK33 (SOT8002-1)

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PXP6R7-30QL v.1	20210105	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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